

### ST9402SRG-VB Datasheet

## N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$\mathbf{R}_{DS(on)}$ (Ω) $\mathbf{I}_{D}$ (A) <sup>e</sup>		Q <sub>g</sub> (Typ.)			
	0.028 at V <sub>GS</sub> = 4.5 V	6 <sup>a</sup>				
20	0.042 at V <sub>GS</sub> = 2.5 V	6 <sup>a</sup>	8.8 nC			
	0.050 at V <sub>GS</sub> = 1.8 V	5.6				

SOT-23

Top View

3 D

G 1

S 2

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- DC/DC Converters
- Load Switch for Portable Applications

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage Gate-Source Voltage		V <sub>DS</sub>		20	
		V <sub>GS</sub>		± 12	
	T <sub>C</sub> = 25 °C		6 <sup>a</sup>		
Continuous Droin Current (T 150 °C)	T <sub>C</sub> = 70 °C		5.1		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C		5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		4 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	20		
Quality of the Design Divide Quarter	T <sub>C</sub> = 25 °C		1.75		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.04 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		2.1		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		1.3	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.25 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		0.8 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera		260	U		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	80	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	60	0/10		

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 °C/W.

e. Based on T\_C = 25 °C.

FREE

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<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C, u$	1		Min	Tree	Max	llait
Parameter Static	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	20			V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	VGS - 0 V, ID - 200 p. (	20	25		v
	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	- 2.6		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient Gate-Source Threshold Voltage		$V_{DS} = V_{GS}$ , $I_{D} = 250 \ \mu A$	0.45	- 2.0	1.0	V
5	V <sub>GS(th)</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$	0.45		± 100	-
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = 10 V$ $V_{DS} = 20 V, V_{GS} = 0 V$				nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70 \text{ °C}$			1 10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	20			A
	D(011)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$	-	0.028		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 4.7 \text{ A}$		0.042		Ω
	20(01)	$V_{GS} = 1.8 \text{ V}, I_D = 4.3 \text{ A}$		0.050		-
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{\rm DS} = 10$ V, I <sub>D</sub> = 5.0 A		24		S
Dynamic <sup>b</sup>	010					
Input Capacitance	C <sub>iss</sub>			865		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		105		
Reverse Transfer Capacitance	C <sub>rss</sub>			55		р. 
		$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 5.0 \text{ A}$		12	18	
Total Gate Charge	Qg			8.8	10	-
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5.0 A		1.1		nC
Gate-Drain Charge	Q <sub>gd</sub>			0.7		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.5	2.4	4.8	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		17	26	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong \text{4}$ A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		31	47	
Fall Time	t <sub>f</sub>			8	16	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		13	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong \text{4 A, V}_\text{GEN} = \text{5 V, R}_\text{g} = \text{1 } \Omega$		21	32	-
Fall Time	t <sub>f</sub>			6	12	
Drain-Source Body Diode Characteristic	s		L	1		L
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			1.75	•
Pulse Diode Forward Current	I <sub>SM</sub>				20	A
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 4 A, V_{GS} = 0 V$		0.75	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			12	20	ns
Body Diode Reverse Recovery Charge				5	10	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 4 \text{ A, dl/dt} = 100 \text{ A/}\mu\text{s, } T_J = 25 \text{ °C}$		7		
Reverse Recovery Rise Time	t <sub>b</sub>			5		ns
Notes:			1	1		1

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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- 55 °C

1.5

20

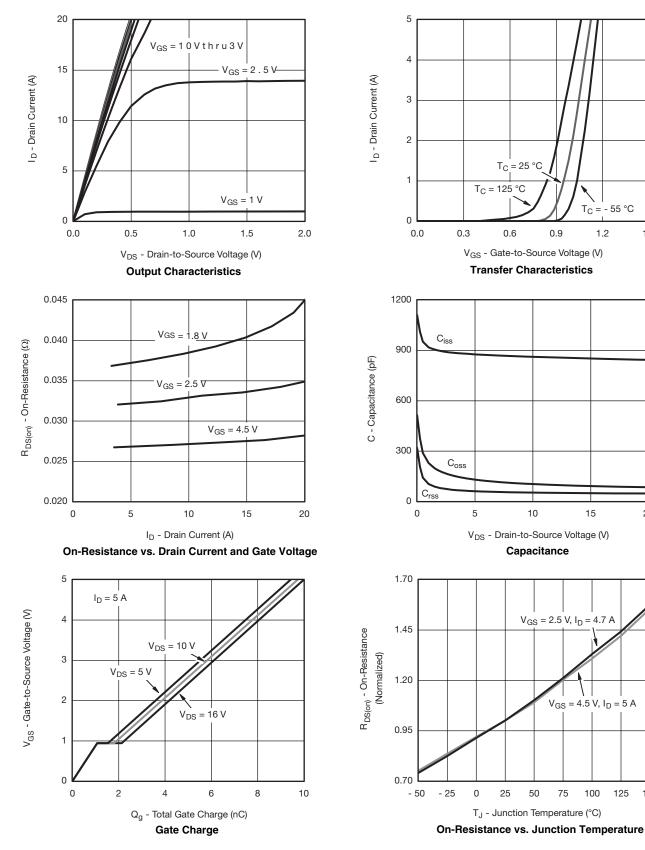
T<sub>C</sub> =

15

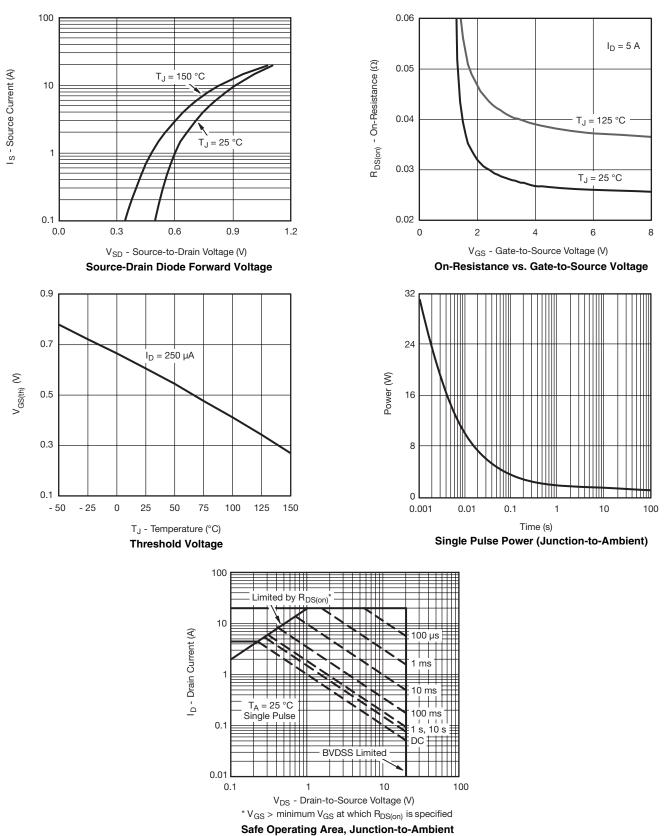
100

125 150

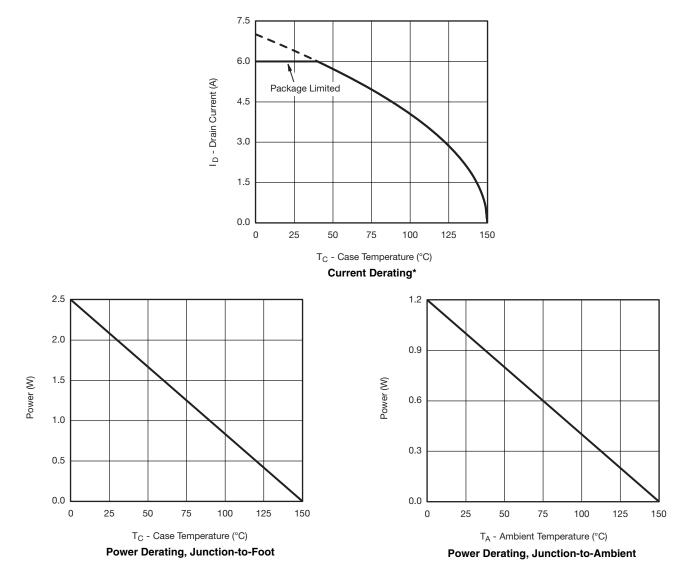
1.2





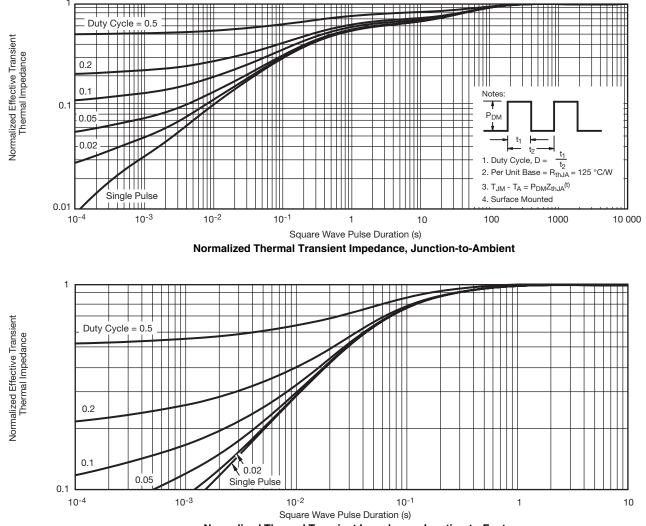






\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

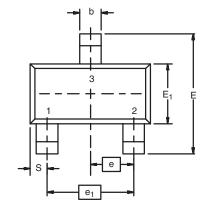




Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	IETERS	INCHES		
	Min	Мах	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025	0.025 Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01	•	·		



#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



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